

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3817852

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHRINIVAS PURANDARE	11/05/2014
GEENA MALHOTRA	10/23/2014
RECEIVING PARTY DATA	
Name:	CIPLA LIMITED
Street Address:	CIPLA HOUSE, PENINSULA BUSINESS PARK
Internal Address:	GANPATRAO KADAM MARG, LOWER PAREL
City:	MUMBAI
State/Country:	INDIA
Postal Code:	400013
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14389684
CORRESPONDENCE DATA	
Fax Number:	(972)731-2289
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	972-731-2288
Email:	dallaspatents@dfw.conleyrose.com
Correspondent Name:	CONLEY ROSE, P.C.
Address Line 1:	5601 GRANITE PARKWAY
Address Line 2:	SUITE 500
Address Line 4:	PLANO, TEXAS 75024
ATTORNEY DOCKET NUMBER:	4137-13300
NAME OF SUBMITTER:	RODNEY B. CARROLL
SIGNATURE:	/Rodney B. Carroll/
DATE SIGNED:	04/06/2016
Total Attachments: 2	
source=Executed_Assignment#page1.tif	
source=Executed_Assignment#page2.tif	

ASSIGNMENT

WHEREAS, I, among the following inventors, Shrinivas PURANDARE and Geena MALHOTRA, am an inventor of **PHARMACEUTICAL COPMPOSITION** (the "Invention"), and of an application for United States Patent disclosing said invention, Serial No. 14/389,684 filed September 30, 2014, also known as attorney docket number CRT/29415 US (4137-13300) which is a filing under 35 U.S.C. 371 of International Application No. PCT/GB2013/000161 filed on April 10, 2013, which claimed priority to Indian Patent Application No. 1179/MUM/2012 filed on April 11, 2012; and

WHEREAS, CIPLA LIMITED, a corporation created and existing under and by virtue of the laws of India, is desirous of acquiring the entire right, title and interest in and to the aforesaid Invention throughout the world, and all right, title and interest in, to and under any and all Letters Patent of the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell, assign, transfer and set over to CIPLA LIMITED, all right, title and interest in and to the said Invention throughout the world, and said application for U.S. Letters Patent, and any and all other applications for said Invention, including divisional, continuation, provisional, non-provisional, regular, and reissue applications, and any and all Letters Patent of the United States and foreign countries which may be granted therefor, the same to be held and enjoyed by CIPLA LIMITED for its own use and benefit, and for the use and benefit of its successors, assigns, or other legal representatives, to the end of the term or terms for which said Letters Patent of the United States or foreign countries are or may be granted or reissued, as fully and entirely as the same would have been held and enjoyed if this assignment and sale had not been made.

And I hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all Letters Patent of the United States on said Invention or resulting from said application and from any and all divisions, continuations, and reissues thereof, to CIPLA LIMITED, as assignee of my entire interest, and hereby covenant that I have the full right to convey the entire interest herein assigned, and that I have not executed and will not execute any agreement in conflict herewith.

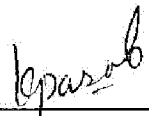
And I further hereby covenant and agree that I will, at any time, upon request, execute and deliver any and all papers that may be necessary or desirable to perfect the title of said Invention and to such Letters Patent as may be granted therefor, to CIPLA LIMITED, its successors, assigns, or other legal representatives and that if CIPLA LIMITED, its successors, assigns or other legal representatives shall desire to file any divisional or continuation applications or to secure a reissue of such Letters Patent, or to file a disclaimer relating thereto, I will upon request, sign all papers, make all rightful oaths and do all lawful acts requisite for the filing of such divisional or continuation application, or such application for reissue and the procuring thereof, and for the filing of such disclaimer, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

And I do further covenant and agree that I will, at any time upon request, communicate to CIPLA LIMITED, its successors, assigns or other legal representatives, such facts relating to said Invention and Letters Patent or the file history thereof as may be known to me, and testify as to the same in any interference or other litigation when requested so to do, without further compensation but at the expense of said assignee, its successors, or other legal representatives.

ASSIGNOR:

Date: 05th November, 2014 Signature: 
Shrinivas PURANDARE

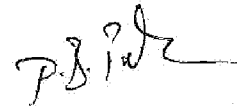
WITNESS:

Date: 05th November, 2014 Signature: 
Name: Kusaji Pasab

ASSIGNOR:

Date: 28th October, 2014 Signature: 
Geena MALHOTRA

WITNESS:

Date: 28th October, 2014 Signature: 
Name: Pallavi B. Patwardhan